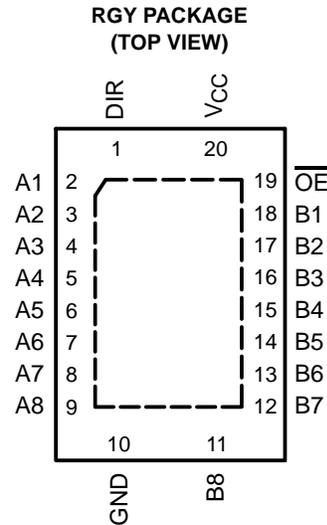


SN74AUCH245 OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES420 – JANUARY 2003

- Optimized for 1.8-V Operation and Is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 2 ns at 1.8 V
- Low Power Consumption, 20- μ A Max I_{CC}
- ± 8 -mA Output Drive at 1.8 V
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



description/ordering information

This octal bus transceiver is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUCH245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

| T_A | PACKAGE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|----------------------------|-----------------------|------------------|
| -40°C to 85°C | QFN – RGY Tape and reel | SN74AUCH245RGYR | MT245 |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated

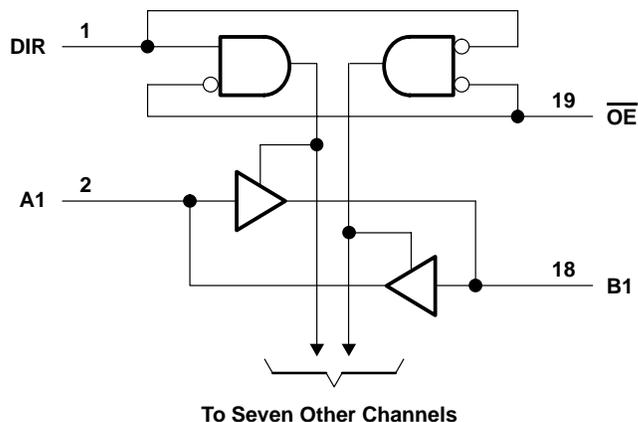
SN74AUCH245 OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES420 – JANUARY 2003

FUNCTION TABLE

| INPUTS | | OPERATION |
|-----------------|-----|-----------------|
| \overline{OE} | DIR | |
| L | L | B data to A bus |
| L | H | A data to B bus |
| H | X | Isolation |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 3.6 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to 3.6 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | -0.5 V to 3.6 V |
| Output voltage range, V_O (see Note 1) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -50 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | -50 mA |
| Continuous output current, I_O | ± 20 mA |
| Continuous current through V_{CC} or GND | ± 100 mA |
| Package thermal impedance, θ_{JA} (see Note 2) | 37°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-5.

recommended operating conditions (see Note 3)

| | | MIN | MAX | UNIT |
|-----------------|------------------------------------|-----------------------------------|------------------------|-----------------|
| V _{CC} | Supply voltage | 0.8 | 2.7 | V |
| V _{IH} | High-level input voltage | V _{CC} = 0.8 V | V _{CC} | V |
| | | V _{CC} = 1.1 V to 1.95 V | 0.65 × V _{CC} | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.7 | |
| V _{IL} | Low-level input voltage | V _{CC} = 0.8 V | 0 | V |
| | | V _{CC} = 1.1 V to 1.95 V | 0.35 × V _{CC} | |
| | | V _{CC} = 2.3 V to 2.7 V | 0.7 | |
| V _I | Input voltage | 0 | 3.6 | V |
| V _O | Output voltage | Active state | 0 | V _{CC} |
| | | 3-state | 0 | 3.6 |
| I _{OH} | High-level output current | V _{CC} = 0.8 V | -0.7 | mA |
| | | V _{CC} = 1.1 V | -3 | |
| | | V _{CC} = 1.4 V | -5 | |
| | | V _{CC} = 1.65 V | -8 | |
| | | V _{CC} = 2.3 V | -9 | |
| I _{OL} | Low-level output current | V _{CC} = 0.8 V | 0.7 | mA |
| | | V _{CC} = 1.1 V | 3 | |
| | | V _{CC} = 1.4 V | 5 | |
| | | V _{CC} = 1.65 V | 8 | |
| | | V _{CC} = 2.3 V | 9 | |
| Δt/Δv | Input transition rise or fall rate | | 20 | ns/V |
| T _A | Operating free-air temperature | -40 | 85 | °C |

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74AUCH245

OCTAL BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCES420 – JANUARY 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | MIN | TYP† | MAX | UNIT |
|---------------------|---|-----------------|----------------------|------|------|------|
| V _{OH} | I _{OH} = -100 μA | 0.8 V to 2.7 V | V _{CC} -0.1 | | | V |
| | I _{OH} = -0.7 mA | 0.8 V | 0.55 | | | |
| | I _{OH} = -3 mA | 1.1 V | 0.8 | | | |
| | I _{OH} = -5 mA | 1.4 V | 1 | | | |
| | I _{OH} = -8 mA | 1.65 V | 1.2 | | | |
| | I _{OH} = -9 mA | 2.3 V | 1.8 | | | |
| V _{OL} | I _{OL} = 100 μA | 0.8 V to 2.7 V | | | 0.2 | V |
| | I _{OL} = 0.7 mA | 0.8 V | 0.25 | | | |
| | I _{OL} = 3 mA | 1.1 V | | | 0.3 | |
| | I _{OL} = 5 mA | 1.4 V | | | 0.4 | |
| | I _{OL} = 8 mA | 1.65 V | | | 0.45 | |
| | I _{OL} = 9 mA | 2.3 V | | | 0.6 | |
| I _I | All inputs V _I = V _{CC} or GND | 0 to 2.7 V | | | ±5 | μA |
| I _{BHL} ‡ | V _I = 0.35 V | 1.1 V | 10 | | | μA |
| | V _I = 0.47 V | 1.4 V | 15 | | | |
| | V _I = 0.57 V | 1.65 V | 20 | | | |
| | V _I = 0.7 V | 2.3 V | 40 | | | |
| I _{BHH} § | V _I = 0.8 V | 1.1 V | -5 | | | μA |
| | V _I = 0.9 V | 1.4 V | -15 | | | |
| | V _I = 1.07 V | 1.65 V | -20 | | | |
| | V _I = 1.7 V | 2.3 V | -40 | | | |
| I _{BHLO} ¶ | V _I = 0 to V _{CC} | 1.3 V | 75 | | | μA |
| | | 1.6 V | 125 | | | |
| | | 1.95 V | 175 | | | |
| | | 2.7 V | 275 | | | |
| I _{BHHO} # | V _I = 0 to V _{CC} | 1.3 V | -75 | | | μA |
| | | 1.6 V | -125 | | | |
| | | 1.95 V | -175 | | | |
| | | 2.7 V | -275 | | | |
| I _{off} | V _I or V _O = 2.7 V | 0 | | | ±10 | μA |
| I _{OZ} | V _O = V _{CC} or GND | 2.7 V | | | ±10 | μA |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 0.8 V to 2.7 V | | | 20 | μA |
| C _i | V _I = V _{CC} or GND | 2.5 V | 2.5 | 3 | | pF |
| C _{io} | V _O = V _{CC} or GND | 2.5 V | 8 | 8.5 | | pF |

† All typical values are at T_A = 25°C.

‡ The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

§ The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

¶ An external driver must source at least I_{BHLO} to switch this node from low to high.

An external driver must sink at least I_{BHHO} to switch this node from high to low.

|| For I/O ports, the parameter I_{OZ} includes the input leakage current.



SN74AUCH245 OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES420 – JANUARY 2003

switching characteristics over recommended operating free-air temperature range, $C_L = 15 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 0.8 \text{ V}$ | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | | | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | | UNIT |
|-----------|-----------------|-------------|--------------------------|--|-----|--|-----|---|-----|-----|--|-----|------|
| | | | TYP | MIN | MAX | MIN | MAX | MIN | TYP | MAX | MIN | MAX | |
| t_{pd} | A or B | B or A | 5 | 1 | 3.2 | 0.6 | 2 | 0.5 | 1 | 1.7 | 0.4 | 1.4 | ns |
| t_{en} | \overline{OE} | A or B | 9 | 1.2 | 4.9 | 1 | 3 | 0.8 | 1.2 | 2.4 | 0.6 | 1.8 | ns |
| t_{dis} | \overline{OE} | A or B | 9.5 | 1.9 | 5.7 | 1.2 | 4 | 0.9 | 1.9 | 4.1 | 0.6 | 2.9 | ns |

switching characteristics over recommended operating free-air temperature range, $C_L = 30 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | | | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | | UNIT |
|-----------|-----------------|-------------|---|-----|-----|--|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | |
| t_{pd} | A or B | B or A | 0.6 | 1.3 | 2.2 | 0.5 | 1.8 | ns |
| t_{en} | \overline{OE} | A or B | 1.1 | 1.5 | 3 | 1.1 | 2.4 | ns |
| t_{dis} | \overline{OE} | A or B | 1.6 | 2.2 | 4 | 0.8 | 2.6 | ns |

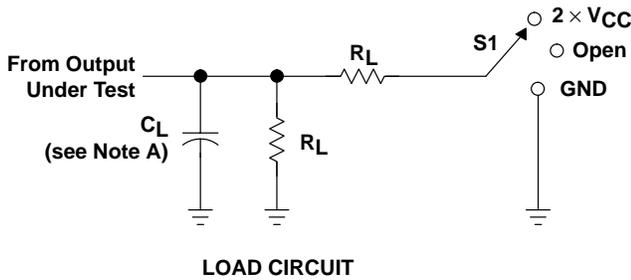
operating characteristics, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | $V_{CC} = 0.8 \text{ V}$ | $V_{CC} = 1.2 \text{ V}$ | $V_{CC} = 1.5 \text{ V}$ | $V_{CC} = 1.8 \text{ V}$ | $V_{CC} = 2.5 \text{ V}$ | UNIT |
|-----------|-------------------------------|----------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|------|
| | | | TYP | TYP | TYP | TYP | TYP | |
| C_{pd} | Power dissipation capacitance | $f = 10 \text{ MHz}$ | 19 | 20 | 21 | 23 | 28 | pF |
| | Outputs enabled | | 1 | 1 | 1 | 1 | 1 | |
| | Outputs disabled | | | | | | | |

SN74AUCH245 OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

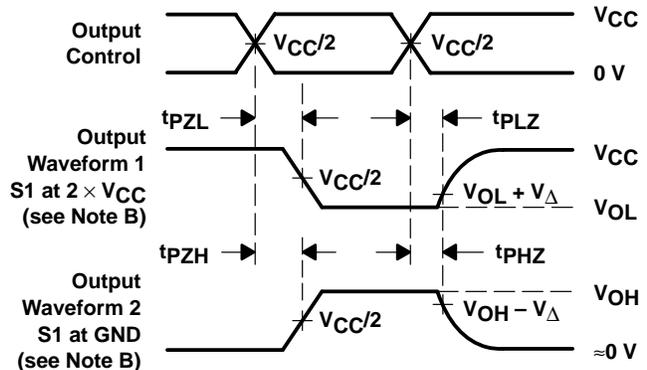
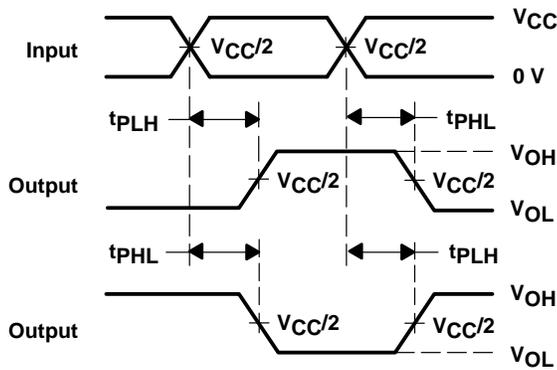
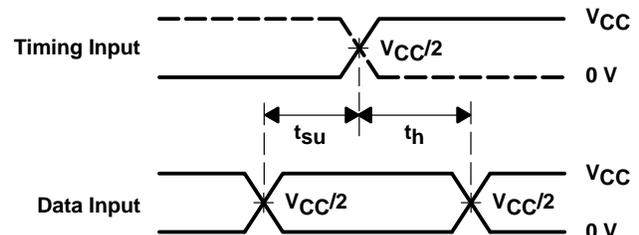
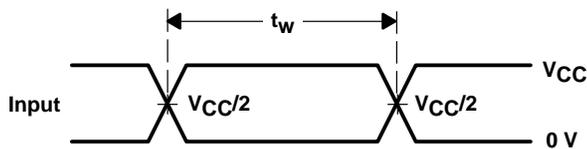
SCES420 – JANUARY 2003

PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|-------------------|-------------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | $2 \times V_{CC}$ |
| t_{PHZ}/t_{PZH} | GND |

| V_{CC} | C_L | R_L | V_{Δ} |
|--------------------|-------|--------------|--------------|
| 0.8 V | 15 pF | 2 k Ω | 0.1 V |
| 1.2 V \pm 0.1 V | 15 pF | 2 k Ω | 0.1 V |
| 1.5 V \pm 0.1 V | 15 pF | 2 k Ω | 0.1 V |
| 1.8 V \pm 0.15 V | 15 pF | 2 k Ω | 0.15 V |
| 2.5 V \pm 0.2 V | 15 pF | 2 k Ω | 0.15 V |
| 1.8 V \pm 0.15 V | 30 pF | 1 k Ω | 0.15 V |
| 2.5 V \pm 0.2 V | 30 pF | 500 Ω | 0.15 V |



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, slew rate ≥ 1 V/ns.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|----------------|
| SN74AUCH245RGYR | ACTIVE | VQFN | RGY | 20 | 3000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | MT245 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

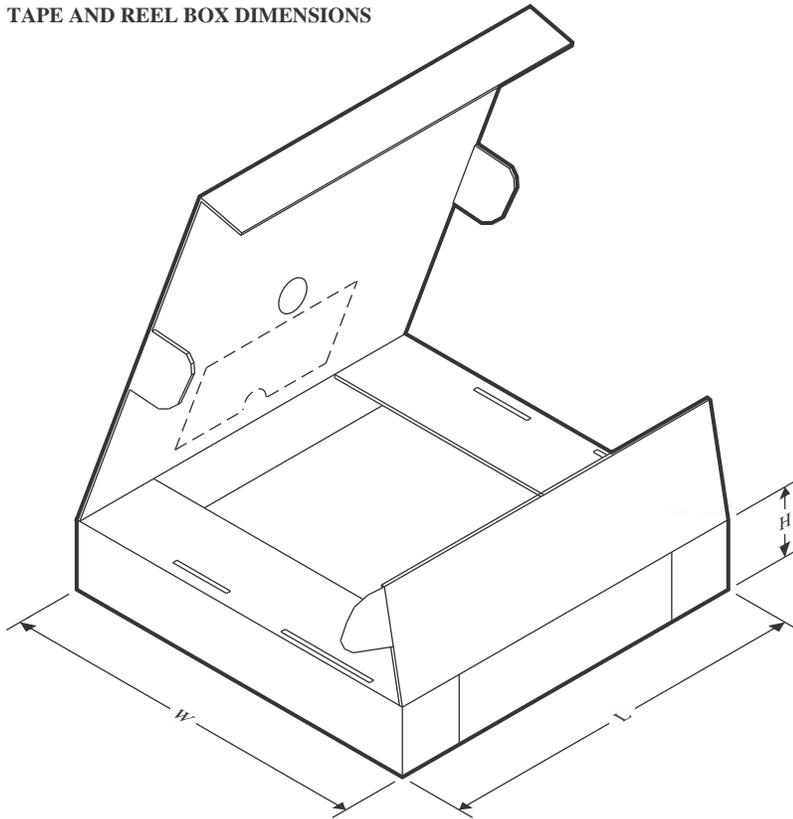
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AUCH245RGYR | VQFN | RGY | 20 | 3000 | 330.0 | 12.4 | 3.8 | 4.8 | 1.6 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AUCH245RGYR | VQFN | RGY | 20 | 3000 | 356.0 | 356.0 | 35.0 |

GENERIC PACKAGE VIEW

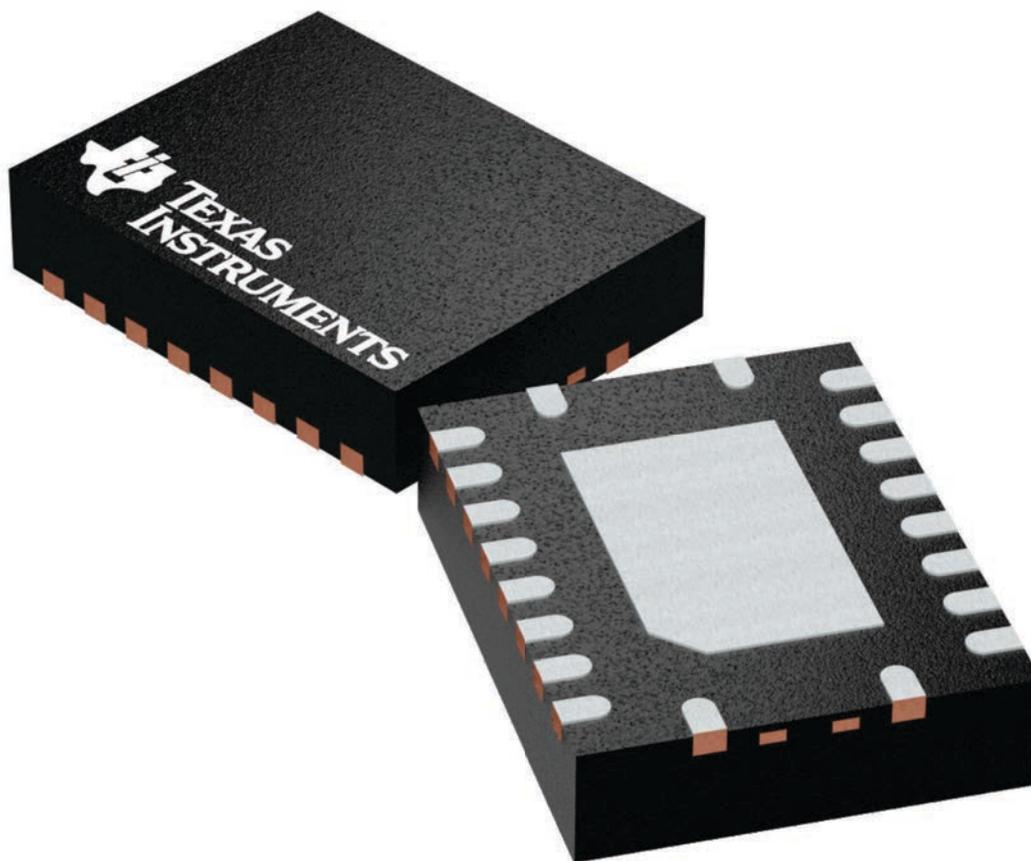
RGY 20

VQFN - 1 mm max height

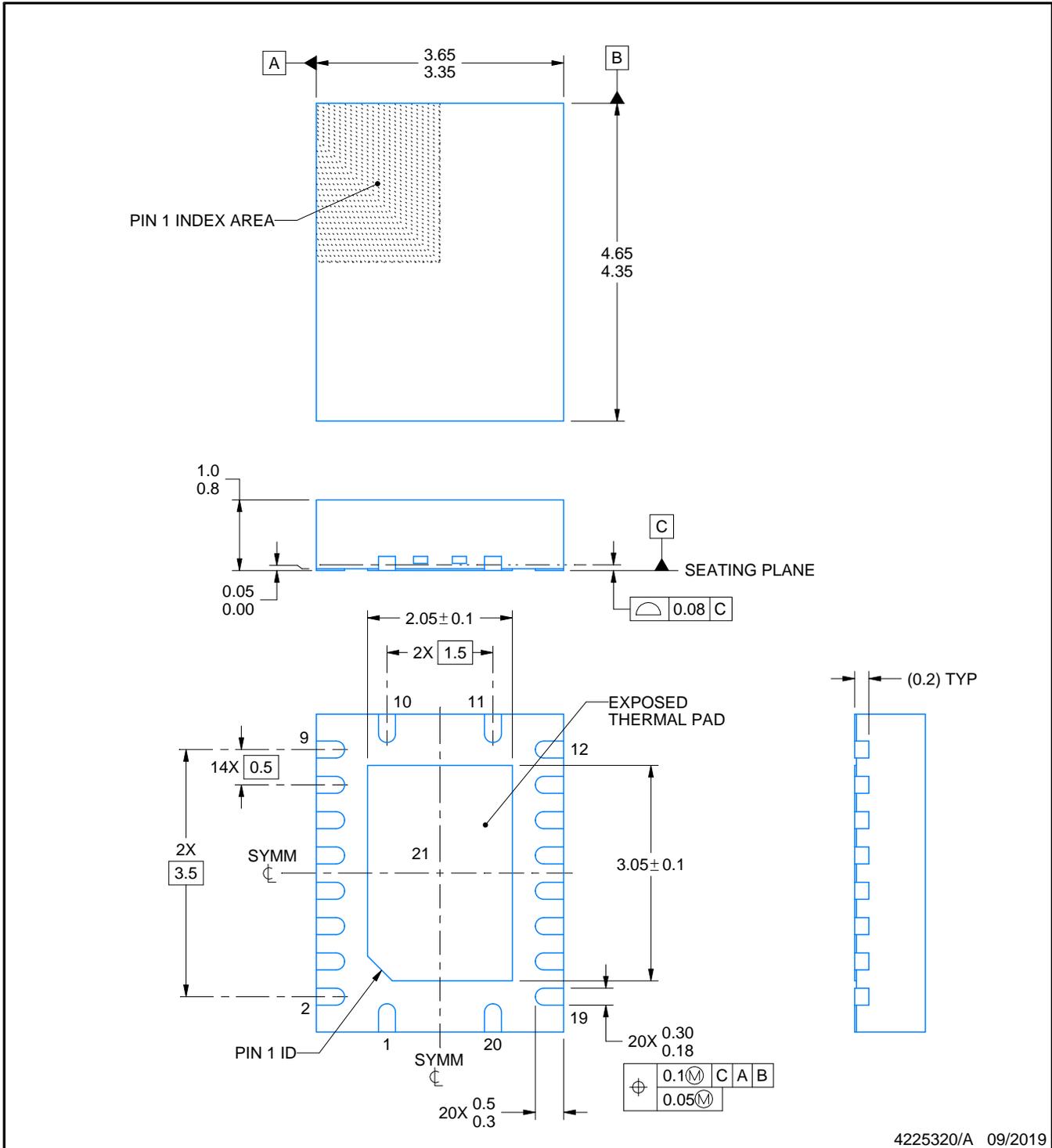
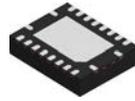
3.5 x 4.5, 0.5 mm pitch

PLASTIC QUAD FGLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4225264/A



4225320/A 09/2019

NOTES:

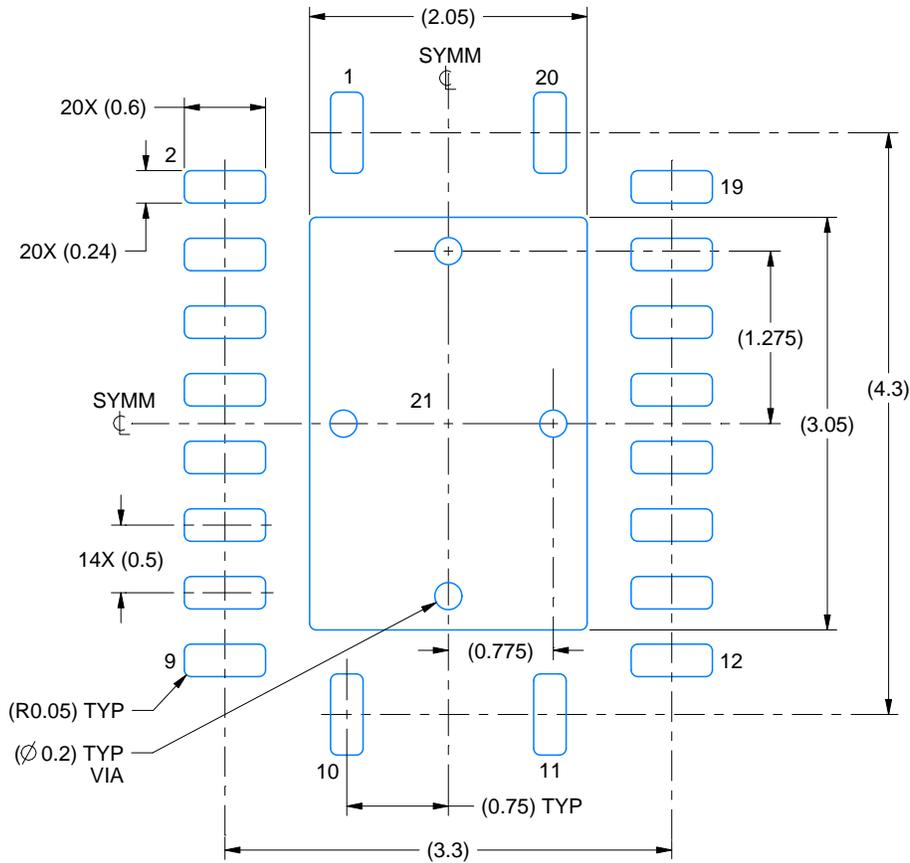
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

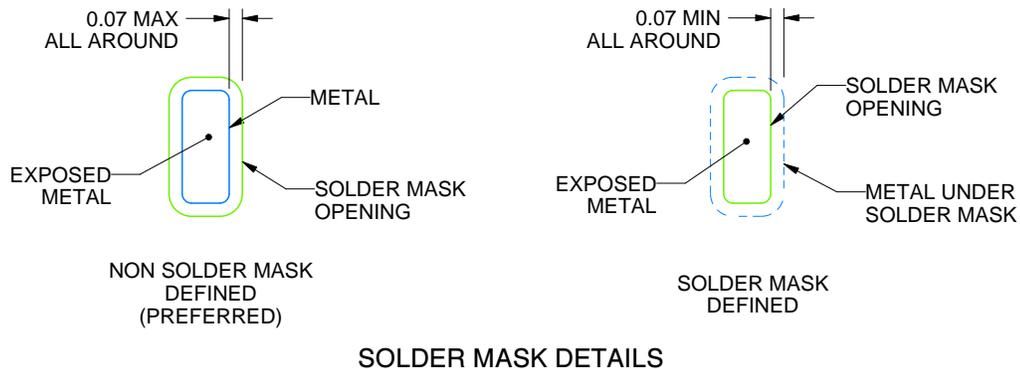
RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



4225320/A 09/2019

NOTES: (continued)

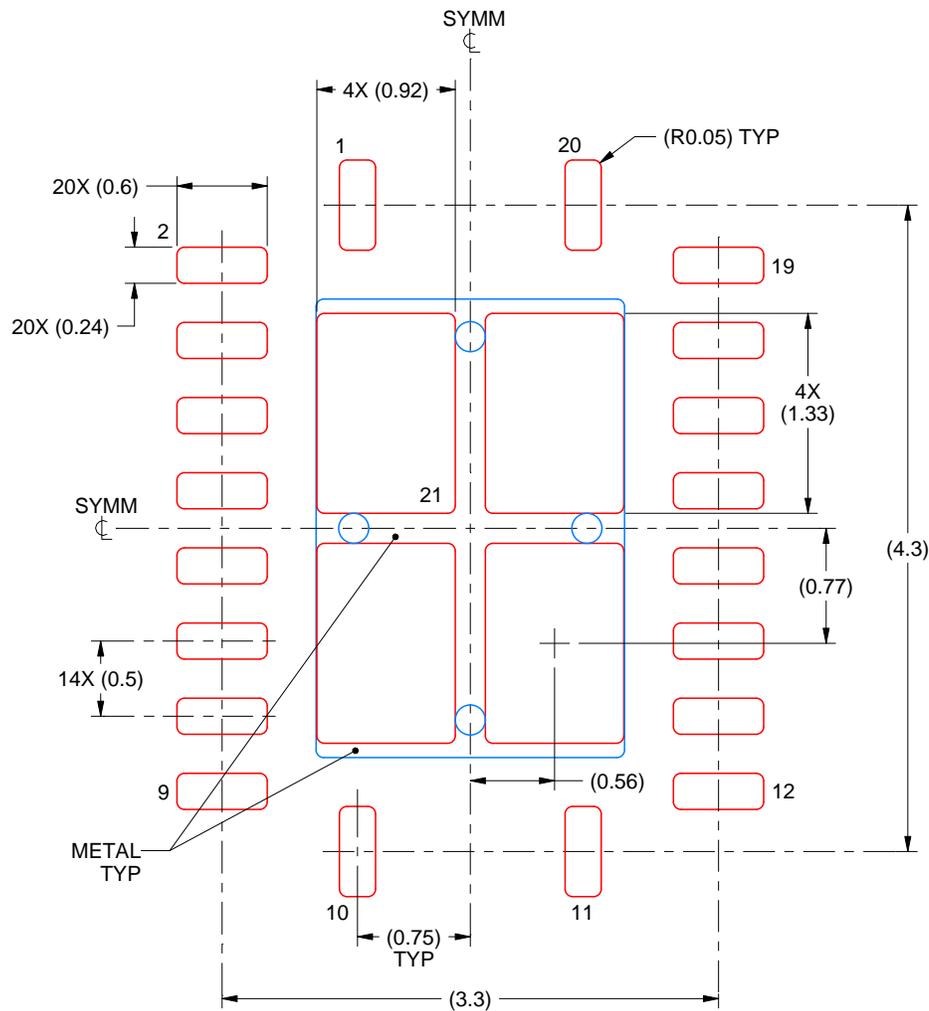
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 21
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:20X

4225320/A 09/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated